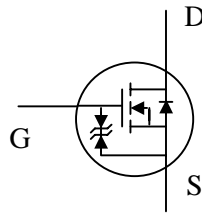




N-channel Enhancement-mode Power MOSFET

- Capable of 2.5V Gate Drive
- Small Package Outline
- Surface Mount Device
- RoHS-compliant, halogen-free



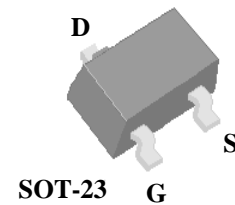
BV_{DSS}	30V
$R_{DS(ON)}$	1.5Ω
I_D	500mA

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP2318GEN-HF-3 is in the popular SOT-23 small surface-mount package which is widely used in commercial and industrial applications where a small board footprint is required.

This device is well suited for use in applications such as load switches.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±16	V
I_D at $T_A=25^{\circ}C$	Continuous Drain Current ³	0.5	A
I_D at $T_A=70^{\circ}C$	Continuous Drain Current ³	0.4	A
I_{DM}	Pulsed Drain Current ¹	2	A
P_D at $T_A=25^{\circ}C$	Total Power Dissipation	0.7	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	180	°C/W

Ordering Information

AP2318GEN-HF-3TR RoHS-compliant halogen-free SOT-23, shipped on tape and reel, 3000pcs/reel



Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to $25^\circ\text{C}, I_D=1\text{mA}$	-	0.04	-	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=4V, I_D=500\text{mA}$	-	-	1.5	Ω
		$V_{GS}=2.5V, I_D=200\text{mA}$	-	-	2.5	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4	-	1.3	V
g_{fs}	Forward Transconductance	$V_{DS}=4V, I_D=500\text{mA}$	-	725	-	mS
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=30V, V_{GS}=0V$	-	-	1	μA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{DS}=24V, V_{GS}=0V$	-	-	25	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 16V, V_{DS}=0V$	-	-	± 60	μA
Q_g	Total Gate Charge ²	$I_D=1A$	-	1.1	1.8	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=25V$	-	0.4	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	0.4	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=15V$	-	17	-	ns
t_r	Rise Time	$I_D=1A$	-	44	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=5V$	-	45	-	ns
t_f	Fall Time	$R_D=15\Omega$	-	55	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	30	48	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	12	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	11	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=0.5A, V_{GS}=0V$	-	-	1.3	V

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test - pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface mounted on 1in^2 copper pad of FR4 board, $t \leq 10\text{sec}$; $400^\circ\text{C}/\text{W}$ when mounted on minimum copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

APEC RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN.



Typical Electrical Characteristics

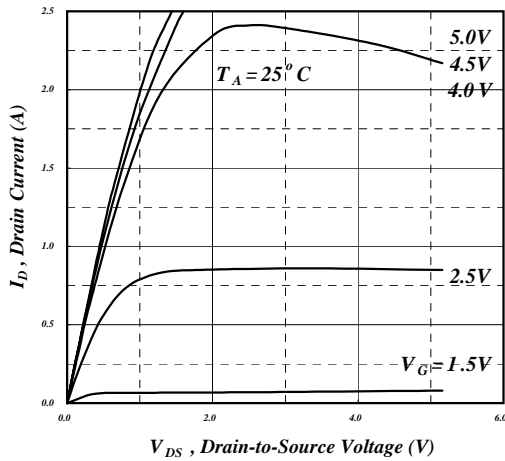


Fig 1. Typical Output Characteristics

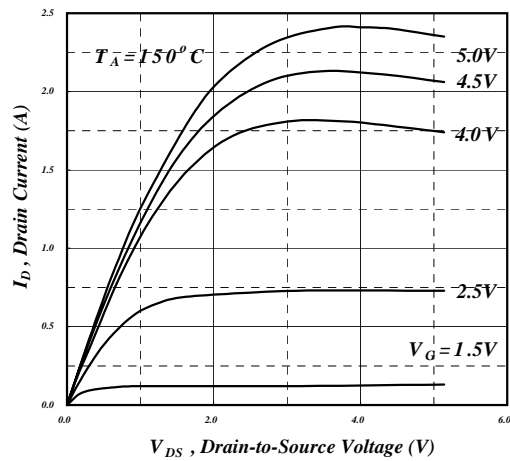


Fig 2. Typical Output Characteristics

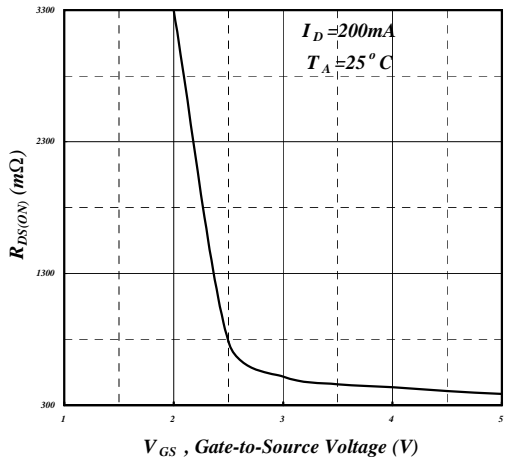


Fig 3. On-Resistance vs. Gate Voltage

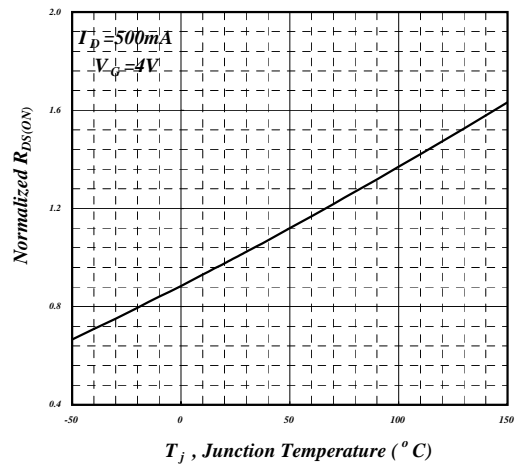


Fig 4. Normalized On-Resistance vs. Junction Temperature

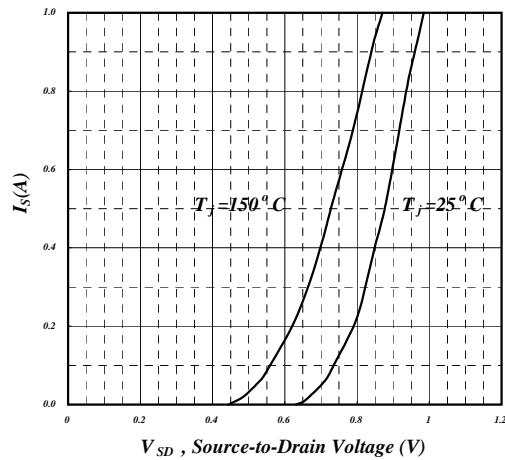


Fig 5. Forward Characteristic of Reverse Diode

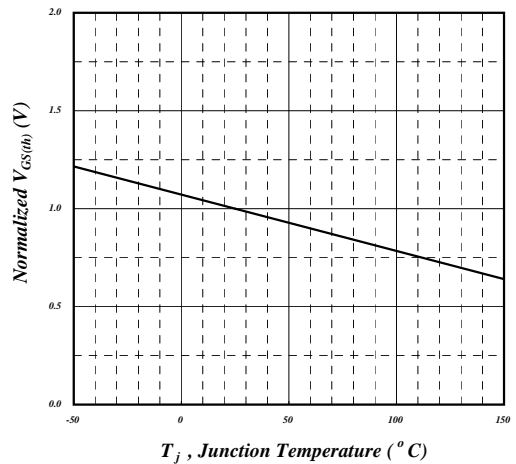


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical Electrical Characteristics (cont.)

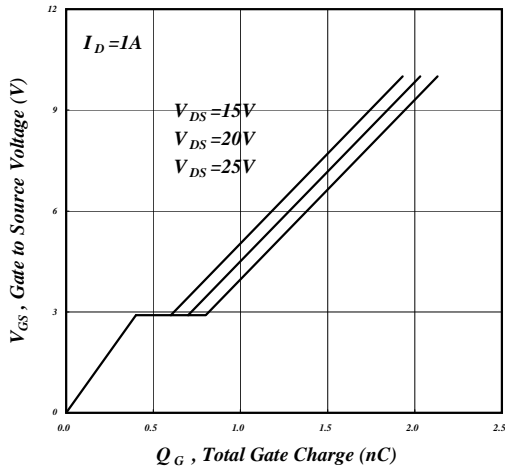


Fig 7. Gate Charge Characteristics

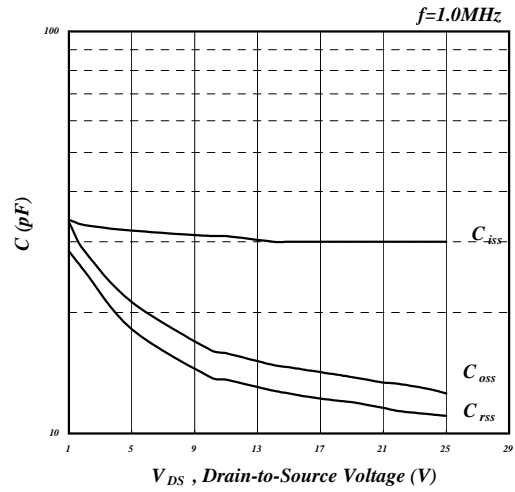


Fig 8. Typical Capacitance Characteristics

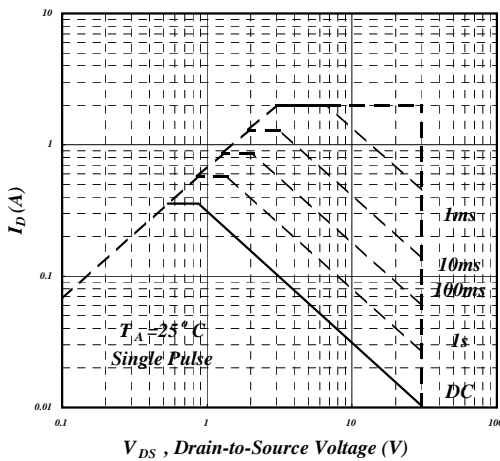


Fig 9. Maximum Safe Operating Area

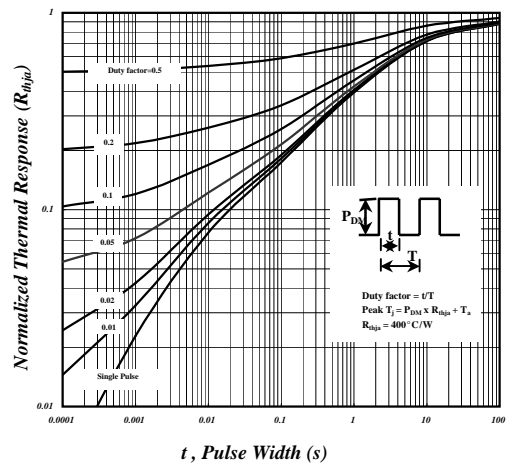


Fig 10. Effective Transient Thermal Impedance

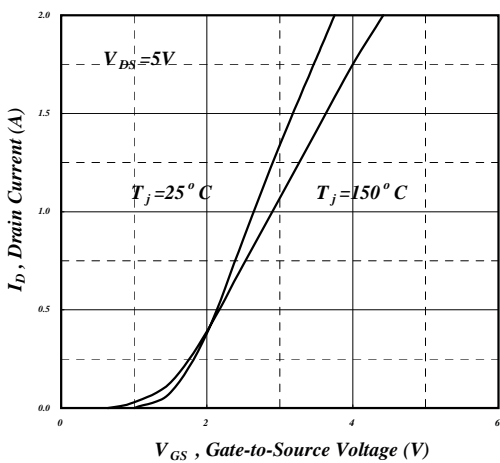


Fig 11. Transfer Characteristics

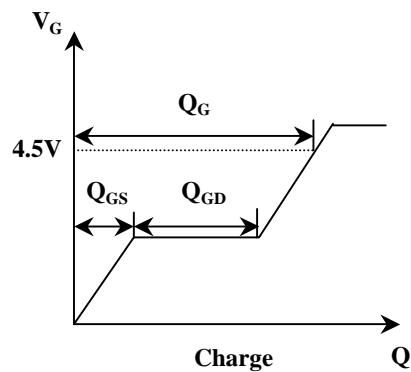
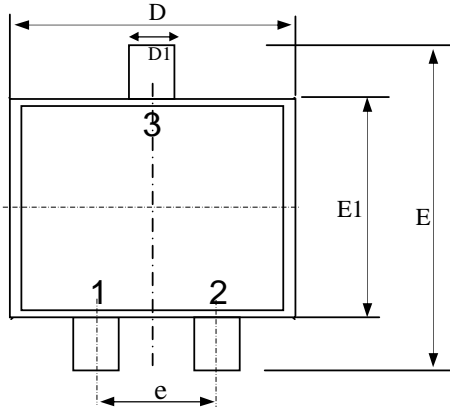


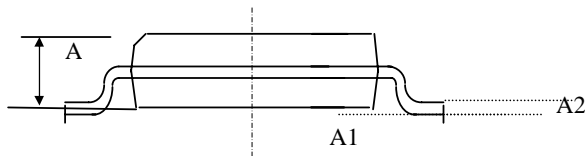
Fig 12. Gate Charge Waveform



Package Dimensions: SOT-23

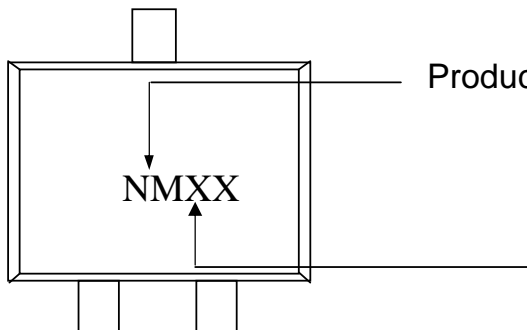


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	1.00	1.15	1.30
A1	0.00	--	0.10
A2	0.10	0.15	0.25
D1	0.30	0.40	0.50
e	1.70	2.00	2.30
D	2.70	2.90	3.10
E	2.40	2.65	3.00
E1	1.40	1.50	1.60



1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information: SOT-23



Product: NM = AP2318GEN-HF-3

Date/lot code

For details of how to convert this to standard YYWW date code format, please contact us directly.